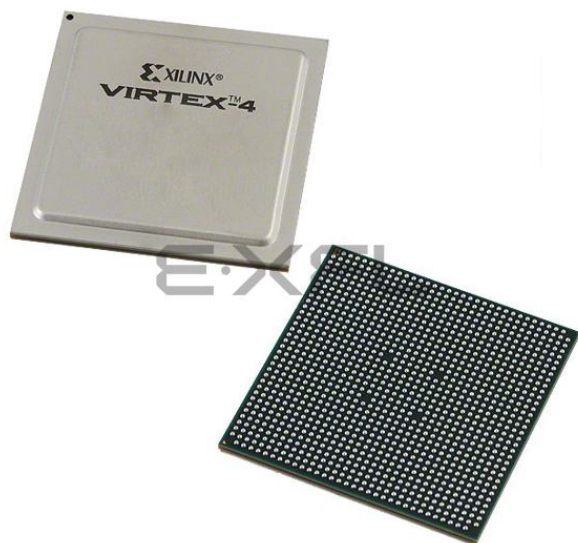




Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	5904
Number of Logic Elements/Cells	53136
Total RAM Bits	4276224
Number of I/O	812
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1148-BBGA, FCBGA
Supplier Device Package	1148-FCPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp50-5ffg1148c

Receiver Buffer

The receiver includes buffers (FIFOs) in the datapath. This section gives the reasons for including the buffers and outlines their operation.

The receiver buffer is required for two reasons:

- *Clock correction* to accommodate the slight difference in frequency between the recovered clock RXRECCLK and the internal FPGA user clock RXUSRCLK
- *Channel bonding* to allow realignment of the input stream to ensure proper alignment of data being read through multiple transceivers

The receiver uses an *elastic buffer*, where "elastic" refers to the ability to modify the read pointer for clock correction and channel bonding.

Comma Detection

Word alignment is dependent on the state of comma detect bits. If comma detect is enabled, the transceiver recognizes up to two 10-bit preprogrammed characters. Upon detection of the character or characters, the comma detect output is driven high and the data is synchronously aligned. If a comma is detected and the data is aligned, no further alignment alteration takes place. If a comma is received and realignment is necessary, the data is realigned and an indication is given at the receiver interface. The realignment indicator is a distinct output.

The transceiver continuously monitors the data for the presence of the 10-bit character(s). Upon each occurrence of a 10-bit character, the data is checked for word alignment. If comma detect is disabled, the data is not aligned to any particular pattern. The programmable option allows a user to align data on comma+, comma-, both, or a unique user-defined and programmed sequence.

Clock Correction

RXRECCLK (the recovered clock) reflects the data rate of the incoming data. RXUSRCLK defines the rate at which the FPGA fabric consumes the data. Ideally, these rates are identical. However, since the clocks typically have different sources, one of the clocks will be faster than the other. The receiver buffer accommodates this difference between the clock rates. See [Figure 12](#).

Nominally, the buffer is always half full. This is shown in the top buffer, [Figure 12](#), where the shaded area represents buffered data not yet read. Received data is inserted via the write pointer under control of RXRECCLK. The FPGA fabric reads data via the read pointer under control of RXUSRCLK. The half full/half empty condition of the buffer gives a cushion for the differing clock rates. This operation continues indefinitely, regardless of whether or not "meaningful" data is being received. When there is no meaningful data to be received, the incoming data will consist of IDLE characters or other padding.

If RXUSRCLK is faster than RXRECCLK, the buffer becomes more empty over time. The clock correction logic

corrects for this by decrementing the read pointer to reread a repeatable byte sequence. This is shown in the middle buffer, [Figure 12](#), where the solid read pointer decrements to the value represented by the dashed pointer.

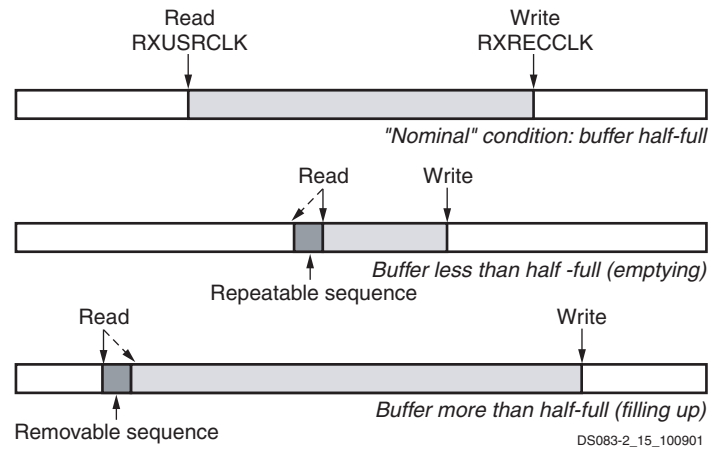


Figure 12: Clock Correction in Receiver

By decrementing the read pointer instead of incrementing it in the usual fashion, the buffer is partially refilled. The transceiver design will repeat a single repeatable byte sequence when necessary to refill a buffer. If the byte sequence length is greater than one, and if attribute CLK_COR_REPEAT_WAIT is 0, then the transceiver may repeat the same sequence multiple times until the buffer is refilled to the desired extent.

Similarly, if RXUSRCLK is slower than RXRECCLK, the buffer will fill up over time. The clock correction logic corrects for this by incrementing the read pointer to skip over a removable byte sequence that need not appear in the final FPGA fabric byte stream. This is shown in the bottom buffer, [Figure 12](#), where the solid read pointer increments to the value represented by the dashed pointer. This accelerates the emptying of the buffer, preventing its overflow. The transceiver design will skip a single byte sequence when necessary to partially empty a buffer. If attribute CLK_COR_REPEAT_WAIT is 0, the transceiver may also skip two consecutive removable byte sequences in one step to further empty the buffer when necessary.

These operations require the clock correction logic to recognize a byte sequence that can be freely repeated or omitted in the incoming data stream. This sequence is generally an IDLE sequence, or other sequence comprised of special values that occur in the gaps separating packets of meaningful data. These gaps are required to occur sufficiently often to facilitate the timely execution of clock correction.

Channel Bonding

Some gigabit I/O standards such as Infiniband specify the use of multiple transceivers in parallel for even higher data rates. Words of data are split into bytes, with each byte sent over a separate channel (transceiver). See [Figure 13](#).

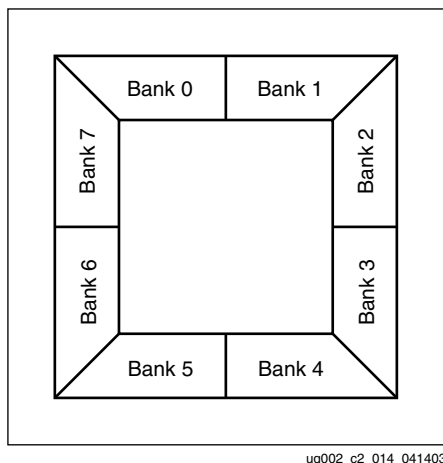


Figure 24: I/O Banks: Wire-Bond Packages (FG)
Top View

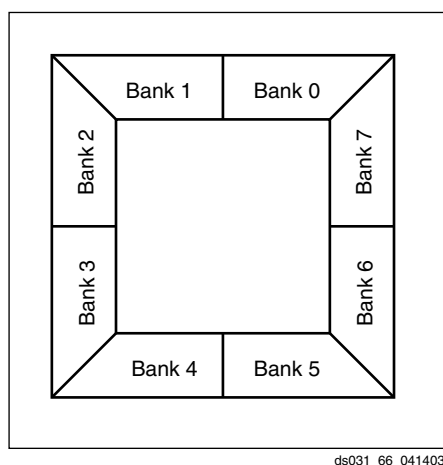


Figure 25: I/O Banks: Flip-Chip Packages (FF)
Top View

Some input standards require a user-supplied threshold voltage (V_{REF}), and certain user-I/O pins are automatically configured as V_{REF} inputs. Approximately one in six of the I/O pins in the bank assume this role.

V_{REF} pins within a bank are interconnected internally, thus only one V_{REF} voltage can be used within each bank. However, for correct operation, all V_{REF} pins in the bank must be connected to the external reference voltage source.

The V_{CCO} and the V_{REF} pins for each bank appear in the device pinout tables. Within a given package, the number of V_{REF} and V_{CCO} pins can vary depending on the size of device. In larger devices, more I/O pins convert to V_{REF} pins. Since these are always a superset of the V_{REF} pins used for smaller devices, it is possible to design a PCB that permits migration to a larger device if necessary.

All V_{REF} pins for the largest device anticipated must be connected to the V_{REF} voltage and not used for I/O. In smaller devices, some V_{CCO} pins used in larger devices do not con-

nect within the package. These unconnected pins can be left unconnected externally, or, if necessary, they can be connected to V_{CCO} to permit migration to a larger device.

Rules for Combining I/O Standards in the Same Bank

The following rules must be obeyed to combine different input, output, and bi-directional standards in the same bank:

1. **Combining output standards only.** Output standards with the same output V_{CCO} requirement can be combined in the same bank.

Compatible example:

SSTL2_I and LVDS_25 outputs

Incompatible example:

SSTL2_I (output $V_{CCO} = 2.5V$) and
LVCMOS33 (output $V_{CCO} = 3.3V$) outputs

2. **Combining input standards only.** Input standards with the same input V_{CCO} and input V_{REF} requirements can be combined in the same bank.

Compatible example:

LVCMOS15 and HSTL_IV inputs

Incompatible example:

LVCMOS15 (input $V_{CCO} = 1.5V$) and
LVCMOS18 (input $V_{CCO} = 1.8V$) inputs

Incompatible example:

HSTL_I_DCI_18 ($V_{REF} = 0.9V$) and
HSTL_IV_DCI_18 ($V_{REF} = 1.1V$) inputs

3. **Combining input standards and output standards.** Input standards and output standards with the same input V_{CCO} and output V_{CCO} requirement can be combined in the same bank.

Compatible example:

LVDS_25 output and HSTL_I input

Incompatible example:

LVDS_25 output (output $V_{CCO} = 2.5V$) and
HSTL_I_DCI_18 input (input $V_{CCO} = 1.8V$)

4. **Combining bi-directional standards with input or output standards.** When combining bi-directional I/O with other standards, make sure the bi-directional standard can meet rules 1 through 3 above.

5. **Additional rules for combining DCI I/O standards.**

- a. No more than one Single Termination type (input or output) is allowed in the same bank.

Incompatible example:

HSTL_IV_DCI input and HSTL_III_DCI input

- b. No more than one Split Termination type (input or output) is allowed in the same bank.

Incompatible example:

HSTL_I_DCI input and HSTL_II_DCI input

The implementation tools will enforce the above design rules.

Table 12, page 30, summarizes all standards and voltage supplies.

SelectIO-Ultra DC Input and Output Levels

Values for V_{IL} and V_{IH} are recommended input voltages. Values for I_{OL} and I_{OH} are guaranteed over the recommended operating conditions at the V_{OL} and V_{OH} test points. Only selected standards are tested. These are cho-

sen to ensure that all standards meet their specifications. The selected standards are tested at minimum V_{CCO} with the respective V_{OL} and V_{OH} voltage levels shown. Other standards are sample tested.

Table 6: DC Input and Output Levels

IOSTANDARD Attribute	V_{IL}		V_{IH}		V_{OL}	V_{OH}	I_{OL}	I_{OH}
	V, min	V, max	V, min	V, max	V, max	V, min	mA	mA
LVTTL	-0.2	0.8	2.0	3.45	0.4	2.4	24	-24
LVC MOS33	-0.2	0.8	2.0	3.45	0.4	$V_{CCO} - 0.4$	24	-24
LVC MOS25	-0.2	0.7	1.7	$V_{CCO} + 0.4$	0.4	$V_{CCO} - 0.4$	24	-24
LVC MOS18	-0.2	30% V_{CCO}	70% V_{CCO}	$V_{CCO} + 0.4$	0.4	$V_{CCO} - 0.45$	16	-16
LVC MOS15	-0.2	30% V_{CCO}	70% V_{CCO}	$V_{CCO} + 0.4$	0.4	$V_{CCO} - 0.45$	16	-16
PCI33_3	-0.2	30% V_{CCO}	50% V_{CCO}	3.6	10% V_{CCO}	90% V_{CCO}		
PCI66_3	-0.2	30% V_{CCO}	50% V_{CCO}	3.6	10% V_{CCO}	90% V_{CCO}		
PCIX	-0.2	Note (1)	Note (1)	Note (1)	Note (1)	Note (1)	Note (1)	Note (1)
GTLP	-0.2	$V_{REF} - 0.1$	$V_{REF} + 0.1$	$V_{CCO} + 0.4$	0.6	n/a	36	n/a
GTL	-0.2	$V_{REF} - 0.05$	$V_{REF} + 0.05$	$V_{CCO} + 0.4$	0.4	n/a	40	n/a
HSTL_I	-0.2	$V_{REF} - 0.1$	$V_{REF} + 0.1$	$V_{CCO} + 0.4$	0.4 ⁽²⁾	$V_{CCO} - 0.4$	8 ⁽²⁾	-8 ⁽²⁾
HSTL_II	-0.2	$V_{REF} - 0.1$	$V_{REF} + 0.1$	$V_{CCO} + 0.4$	0.4 ⁽²⁾	$V_{CCO} - 0.4$	16 ⁽²⁾	-16 ⁽²⁾
HSTL_III	-0.2	$V_{REF} - 0.1$	$V_{REF} + 0.1$	$V_{CCO} + 0.4$	0.4 ⁽²⁾	$V_{CCO} - 0.4$	24 ⁽²⁾	-8 ⁽²⁾
HSTL_IV	-0.2	$V_{REF} - 0.1$	$V_{REF} + 0.1$	$V_{CCO} + 0.4$	0.4 ⁽²⁾	$V_{CCO} - 0.4$	48 ⁽²⁾	-8 ⁽²⁾
SSTL2_I	-0.2	$V_{REF} - 0.15$	$V_{REF} + 0.15$	$V_{CCO} + 0.3$	$V_{TT} - 0.61$	$V_{TT} + 0.61$	8.1	-8.1
SSTL2_II	-0.2	$V_{REF} - 0.15$	$V_{REF} + 0.15$	$V_{CCO} + 0.3$	$V_{TT} - 0.81$	$V_{TT} + 0.81$	16.2	-16.2
SSTL18_I	-0.2	$V_{REF} - 0.125$	$V_{REF} + 0.125$	$V_{CCO} + 0.3$	$V_{TT} - 0.61$	$V_{TT} + 0.61$	6.7	-6.7
SSTL18_II	-0.2	$V_{REF} - 0.125$	$V_{REF} + 0.125$	$V_{CCO} + 0.3$	$V_{TT} - 0.61$	$V_{TT} + 0.61$	13.4	-13.4

Notes:

1. Tested according to relevant specifications.
2. This applies to 1.5V and 1.8V HSTL.

LDT DC Specifications (LDT_25)

Table 7: LDT DC Specifications

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V_{CCO}		2.38	2.5	2.63	V
Differential Output Voltage	V_{OD}	$R_T = 100$ ohm across Q and $\bar{Q}$ signals	495	600	715	mV
Change in V_{OD} Magnitude	ΔV_{OD}		-15		15	mV
Output Common Mode Voltage	V_{OCM}	$R_T = 100$ ohm across Q and $\bar{Q}$ signals	495	600	715	mV
Change in V_{OS} Magnitude	ΔV_{OCM}		-15		15	mV
Input Differential Voltage	V_{ID}		200	600	1000	mV
Change in V_{ID} Magnitude	ΔV_{ID}		-15		15	mV
Input Common Mode Voltage	V_{ICM}		440	600	780	mV
Change in V_{ICM} Magnitude	ΔV_{ICM}		-15		15	mV

LVDS DC Specifications (LVDS_25)

Table 8: LVDS DC Specifications

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V_{CCO}		2.38	2.5	2.63	V
Output High Voltage for Q and $\overline{Q}$	V_{OH}	$R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals			1.602	V
Output Low Voltage for Q and $\overline{Q}$	V_{OL}	$R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals	0.898			V
Differential Output Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High	V_{ODIFF}	$R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals	247	350	454	mV
Output Common-Mode Voltage	V_{OCM}	$R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals	1.125	1.250	1.375	V
Differential Input Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High	V_{IDIFF}	Common-mode input voltage = 1.25V	100	350	600	mV
Input Common-Mode Voltage	V_{ICM}	Differential input voltage = ± 350 mV	0.3	1.2	2.2	V

Extended LVDS DC Specifications (LVDS_EXT_25)

Table 9: Extended LVDS DC Specifications

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V_{CCO}		2.38	2.5	2.63	V
Output High Voltage for Q and $\overline{Q}$	V_{OH}	$R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals			1.785	V
Output Low Voltage for Q and $\overline{Q}$	V_{OL}	$R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals	0.715			V
Differential Output Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High	V_{ODIFF}	$R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals	440		820	mV
Output Common-Mode Voltage	V_{OCM}	$R_T = 100\ \Omega$ across Q and $\overline{Q}$ signals	1.125	1.250	1.375	V
Differential Input Voltage (Q – $\overline{Q}$), Q = High ($\overline{Q}$ – Q), $\overline{Q}$ = High	V_{IDIFF}	Common-mode input voltage = 1.25V	100		1000	mV
Input Common-Mode Voltage	V_{ICM}	Differential input voltage = ± 350 mV	0.3	1.2	2.2	V

LVPECL DC Specifications (LVPECL_25)

These values are valid when driving a 100 Ω differential load only, i.e., a 100 Ω resistor between the two receiver pins. The V_{OH} levels are 200 mV below standard LVPECL levels and are compatible with devices tolerant of lower

common-mode ranges. Table 10 summarizes the DC output specifications of LVPECL. For more information on using LVPECL, see the *Virtex-II Pro Platform FPGA User Guide*.

Table 10: LVPECL DC Specifications

DC Parameter	$V_{CCO} = 2.375V$		$V_{CCO} = 2.5V$		$V_{CCO} = 2.625V$		Units
	Min	Max	Min	Max	Min	Max	
V_{OH}	1.35	1.495	1.475	1.62	1.6	1.745	V
V_{OL}	0.565	0.755	0.69	0.88	0.815	1.005	V
V_{IH}	0.8	2.0	0.8	2.0	0.8	2.0	V
V_{IL}	0.5	1.7	0.5	1.7	0.5	1.7	V
Differential Input Voltage	0.100	1.5	0.100	1.5	0.100	1.5	V

Source-Synchronous Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Virtex-II Pro source-synchronous transmitter and receiver data-valid windows.

Table 64: Duty Cycle Distortion and Clock-Tree Skew

Description	Symbol	Device	Speed Grade			Units
			–7	–6	–5	
Duty Cycle Distortion ⁽¹⁾	T_{DCD_LOCAL}	All	0.10	0.10	0.20	ns
	T_{DCD_CLK180}		0.10	0.11	0.13	ns
Clock Tree Skew ⁽²⁾	T_{CKSKEW}	XC2VP2	0.13	0.13	0.13	ns
		XC2VP4	0.13	0.13	0.13	ns
		XC2VP7	0.13	0.13	0.13	ns
		XC2VP20	0.20	0.21	0.22	ns
		XC2VPX20	0.20	0.21	0.22	ns
		XC2VP30	0.20	0.22	0.24	ns
		XC2VP40	0.33	0.34	0.35	ns
		XC2VP50	0.40	0.41	0.42	ns
		XC2VP70	0.54	0.59	0.64	ns
		XC2VPX70	0.54	0.59	0.64	ns
		XC2VP100	N/A	0.79	0.87	ns

Notes:

- These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
 T_{DCD_LOCAL} applies to cases where the dedicated path from the DCM to the BUFG is bypassed and where local (IOB) inversion is used to provide the negative-edge clock to the DDR element in the I/O. Users must follow the implementation guidelines contained in [XAPP685](#) for these specifications to apply.
 T_{DCD_CLK180} applies to cases where the CLK180 output of the DCM is used to provide the negative-edge clock to the DDR element in the I/O.
- This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.

Table 6: FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
7	IO_L88N_7/VREF_7	L5			
7	IO_L86P_7	L6			
7	IO_L86N_7	K6			
7	IO_L85P_7	K1			
7	IO_L85N_7	K2			
7	IO_L60P_7	K3	NC		
7	IO_L60N_7	K4	NC		
7	IO_L58P_7	K5	NC		
7	IO_L58N_7/VREF_7	J5	NC		
7	IO_L56P_7	J1	NC		
7	IO_L56N_7	J2	NC		
7	IO_L55P_7	J3	NC		
7	IO_L55N_7	J4	NC		
7	IO_L54P_7	J6	NC		
7	IO_L54N_7	H5	NC		
7	IO_L52P_7	H1	NC		
7	IO_L52N_7/VREF_7	H2	NC		
7	IO_L50P_7	H3	NC		
7	IO_L50N_7	H4	NC		
7	IO_L49P_7	G1	NC		
7	IO_L49N_7	G2	NC		
7	IO_L48P_7	G3	NC		
7	IO_L48N_7	G4	NC		
7	IO_L46P_7	G5	NC		
7	IO_L46N_7/VREF_7	F5	NC		
7	IO_L43P_7	F1	NC		
7	IO_L43N_7	F2	NC		
7	IO_L06P_7	F3			
7	IO_L06N_7	F4			
7	IO_L04P_7	E1			
7	IO_L04N_7/VREF_7	E2			
7	IO_L03P_7	E3			
7	IO_L03N_7	E4			
7	IO_L02P_7	D1			
7	IO_L02N_7	D2			
7	IO_L01P_7/VRN_7	C1			
7	IO_L01N_7/VRP_7	C2			

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
N/A	AVCCAUXRX21	AE7			
N/A	VTRXPAD21	AE6			
N/A	RXNPAD21	AF7			
N/A	RXPPAD21	AF6			
N/A	GNDA21	AD6			
N/A	TXPPAD21	AF5			
N/A	TXNPAD21	AF4			
N/A	VTTXPAD21	AE4			
N/A	AVCCAUXTX21	AE5			
N/A	M2	AD4			
N/A	M0	AF3			
N/A	M1	AE3			
N/A	TDI	D3			
N/A	VCCINT	G10			
N/A	VCCINT	G13			
N/A	VCCINT	G14			
N/A	VCCINT	G17			
N/A	VCCINT	J9			
N/A	VCCINT	J18			
N/A	VCCINT	K7			
N/A	VCCINT	K10			
N/A	VCCINT	K11			
N/A	VCCINT	K16			
N/A	VCCINT	K17			
N/A	VCCINT	K20			
N/A	VCCINT	L10			
N/A	VCCINT	L17			
N/A	VCCINT	N7			
N/A	VCCINT	N20			
N/A	VCCINT	P7			
N/A	VCCINT	P20			
N/A	VCCINT	T10			
N/A	VCCINT	T17			
N/A	VCCINT	U7			

Table 9: FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
7	IO_L54N_7		L26			
7	IO_L53P_7		N26			
7	IO_L53N_7		N25			
7	IO_L52P_7		M30			
7	IO_L52N_7/VREF_7		L30			
7	IO_L51P_7		K28			
7	IO_L51N_7		K27			
7	IO_L50P_7		N24			
7	IO_L50N_7		N23			
7	IO_L49P_7		L29			
7	IO_L49N_7		K29			
7	IO_L48P_7		J28			
7	IO_L48N_7		J27			
7	IO_L47P_7		M26			
7	IO_L47N_7		M25			
7	IO_L46P_7		K30			
7	IO_L46N_7/VREF_7		J30			
7	IO_L45P_7		K26			
7	IO_L45N_7		K25			
7	IO_L44P_7		M24			
7	IO_L44N_7		M23			
7	IO_L43P_7		J29			
7	IO_L43N_7		H29			
7	IO_L42P_7		H28	NC		
7	IO_L42N_7		H27	NC		
7	IO_L41P_7		L24	NC		
7	IO_L41N_7		L23	NC		
7	IO_L40P_7		G30	NC		
7	IO_L40N_7/VREF_7		G29	NC		
7	IO_L39P_7		G28	NC		
7	IO_L39N_7		G27	NC		
7	IO_L38P_7		J26	NC		
7	IO_L38N_7		J25	NC		
7	IO_L37P_7		F30	NC		
7	IO_L37N_7		F29	NC		
7	IO_L36P_7		F28	NC		

Table 9: FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
N/A	GND		U18			
N/A	GND		U17			
N/A	GND		U16			
N/A	GND		U15			
N/A	GND		U14			
N/A	GND		U13			
N/A	GND		U12			
N/A	GND		U6			
N/A	GND		T19			
N/A	GND		T18			
N/A	GND		T17			
N/A	GND		T16			
N/A	GND		T15			
N/A	GND		T14			
N/A	GND		T13			
N/A	GND		T12			
N/A	GND		R19			
N/A	GND		R18			
N/A	GND		R17			
N/A	GND		R16			
N/A	GND		R15			
N/A	GND		R14			
N/A	GND		R13			
N/A	GND		R12			
N/A	GND		P25			
N/A	GND		P19			
N/A	GND		P18			
N/A	GND		P17			
N/A	GND		P16			
N/A	GND		P15			
N/A	GND		P14			
N/A	GND		P13			
N/A	GND		P12			
N/A	GND		P6			
N/A	GND		N19			
N/A	GND		N18			

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
3	IO_L39P_3	AD4				
3	IO_L38N_3	AB9				
3	IO_L38P_3	AB10				
3	IO_L37N_3	AD5				
3	IO_L37P_3	AD6				
3	IO_L36N_3	AE2				
3	IO_L36P_3	AF2				
3	IO_L35N_3	AD7				
3	IO_L35P_3	AD8				
3	IO_L34N_3	AE4				
3	IO_L34P_3	AE5				
3	IO_L33N_3/VREF_3	AG1				
3	IO_L33P_3	AG2				
3	IO_L32N_3	AC9				
3	IO_L32P_3	AC10				
3	IO_L31N_3	AF3				
3	IO_L31P_3	AF4				
3	IO_L24N_3	AH1	NC			
3	IO_L24P_3	AH2	NC			
3	IO_L23N_3	AE7	NC			
3	IO_L23P_3	AE8	NC			
3	IO_L22N_3	AF5	NC			
3	IO_L22P_3	AF6	NC			
3	IO_L21N_3/VREF_3	AG3	NC			
3	IO_L21P_3	AG4	NC			
3	IO_L20N_3	AD9	NC			
3	IO_L20P_3	AD10	NC			
3	IO_L19N_3	AH3	NC			
3	IO_L19P_3	AH4	NC			
3	IO_L18N_3	AJ1	NC			
3	IO_L18P_3	AJ2	NC			
3	IO_L17N_3	AF7	NC			
3	IO_L17P_3	AF8	NC			
3	IO_L16N_3	AK1	NC			
3	IO_L16P_3	AK2	NC			
3	IO_L15N_3/VREF_3	AG5	NC			
3	IO_L15P_3	AG6	NC			
3	IO_L06N_3	AL1				

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
4	IO_L47N_4	AE15		
4	IO_L47P_4	AD15		
4	IO_L48N_4	AM14		
4	IO_L48P_4	AL14		
4	IO_L49N_4	AP14		
4	IO_L49P_4	AN14		
4	IO_L50_4/No_Pair	AH15		
4	IO_L53_4/No_Pair	AG16		
4	IO_L54N_4	AK15		
4	IO_L54P_4	AJ15		
4	IO_L55N_4	AM15		
4	IO_L55P_4	AL16		
4	IO_L56N_4	AE16		
4	IO_L56P_4	AD16		
4	IO_L57N_4	AP15		
4	IO_L57P_4/VREF_4	AN15		
4	IO_L66N_4	AJ16	NC	
4	IO_L66P_4/VREF_4	AH16	NC	
4	IO_L67N_4	AN16		
4	IO_L67P_4	AM16		
4	IO_L68N_4	AG17		
4	IO_L68P_4	AF17		
4	IO_L69N_4	AJ17		
4	IO_L69P_4/VREF_4	AH17		
4	IO_L73N_4	AL17		
4	IO_L73P_4	AK17		
4	IO_L74N_4/GCLK3S	AE17		
4	IO_L74P_4/GCLK2P	AD17		
4	IO_L75N_4/GCLK1S	AN17		
4	IO_L75P_4/GCLK0P	AM17		
5	IO_L75N_5/GCLK7S	AM18		
5	IO_L75P_5/GCLK6P	AN18		
5	IO_L74N_5/GCLK5S	AD18		
5	IO_L74P_5/GCLK4P	AE18		
5	IO_L73N_5	AK18		
5	IO_L73P_5	AL18		
5	IO_L69N_5/VREF_5	AH18		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
5	IO_L29N_5	AK26	NC	
5	IO_L29P_5	AL26	NC	
5	IO_L28N_5	AL27	NC	
5	IO_L28P_5	AM27	NC	
5	IO_L27N_5/VREF_5	AR28		
5	IO_L27P_5	AT28		
5	IO_L26N_5	AH26		
5	IO_L26P_5	AH27		
5	IO_L25N_5	AL28		
5	IO_L25P_5	AM28		
5	IO_L21N_5	AT29		
5	IO_L21P_5	AU29		
5	IO_L20N_5	AJ27		
5	IO_L20P_5	AJ28		
5	IO_L19N_5	AP29		
5	IO_L19P_5	AR29		
5	IO_L09N_5/VREF_5	AM29		
5	IO_L09P_5	AN29		
5	IO_L08N_5	AK29		
5	IO_L08P_5	AL29		
5	IO_L07N_5/VREF_5	AT30		
5	IO_L07P_5	AU30		
5	IO_L06N_5/VRP_5	AP30		
5	IO_L06P_5/VRN_5	AR30		
5	IO_L05_5/No_Pair	AK28		
5	IO_L03N_5/D4	AM30		
5	IO_L03P_5/D5	AN30		
5	IO_L02N_5/D6	AL30		
5	IO_L02P_5/D7	AK30		
5	IO_L01N_5/RDWR_B	AR31		
5	IO_L01P_5/CS_B	AT31		
6	IO_L01P_6/VRN_6	AU33		
6	IO_L01N_6/VRP_6	AT33		
6	IO_L02P_6	AT32		
6	IO_L02N_6	AR32		
6	IO_L03P_6	AN31		
6	IO_L03N_6/VREF_6	AM31		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	GNDA18	AU16		
N/A	TXPPAD18	AW18		
N/A	TXNPAD18	AW19		
N/A	VTTXPAD18	AV19		
N/A	AVCCAUXTX18	AV18		
N/A	AVCCAUXRX19	AV21		
N/A	VTRXPAD19	AV22		
N/A	RXNPAD19	AW21		
N/A	RXPPAD19	AW22		
N/A	GNDA19	AU24		
N/A	TXPPAD19	AW23		
N/A	TXNPAD19	AW24		
N/A	VTTXPAD19	AV24		
N/A	AVCCAUXTX19	AV23		
N/A	AVCCAUXRX20	AV25		
N/A	VTRXPAD20	AV26		
N/A	RXNPAD20	AW25		
N/A	RXPPAD20	AW26		
N/A	GNDA20	AU27		
N/A	TXPPAD20	AW27		
N/A	TXNPAD20	AW28		
N/A	VTTXPAD20	AV28		
N/A	AVCCAUXTX20	AV27		
N/A	AVCCAUXRX21	AV29		
N/A	VTRXPAD21	AV30		
N/A	RXNPAD21	AW29		
N/A	RXPPAD21	AW30		
N/A	GNDA21	AU31		
N/A	TXPPAD21	AW31		
N/A	TXNPAD21	AW32		
N/A	VTTXPAD21	AV32		
N/A	AVCCAUXTX21	AV31		
N/A	AVCCAUXRX23	AV33		
N/A	VTRXPAD23	AV34		
N/A	RXNPAD23	AW33		
N/A	RXPPAD23	AW34		
N/A	GNDA23	AU34		
N/A	TXPPAD23	AW35		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
0	IO_L34N_0		E30		
0	IO_L34P_0		F30		
0	IO_L35N_0		D30		
0	IO_L35P_0		C30		
0	IO_L36N_0		M28		
0	IO_L36P_0/VREF_0		M29		
0	IO_L78N_0		K29	NC	
0	IO_L78P_0		L29	NC	
0	IO_L83_0/No_Pair		H29	NC	
0	IO_L84N_0		F29	NC	
0	IO_L84P_0		G29	NC	
0	IO_L85N_0		D29	NC	
0	IO_L85P_0		E29	NC	
0	IO_L86N_0		L28	NC	
0	IO_L86P_0		K28	NC	
0	IO_L87N_0		H28	NC	
0	IO_L87P_0/VREF_0		J28	NC	
0	IO_L37N_0		E28		
0	IO_L37P_0		F28		
0	IO_L38N_0		C29		
0	IO_L38P_0		C28		
0	IO_L39N_0		L27		
0	IO_L39P_0		M27		
0	IO_L43N_0		J27		
0	IO_L43P_0		K27		
0	IO_L44N_0		H27		
0	IO_L44P_0		G27		
0	IO_L45N_0		E27		
0	IO_L45P_0/VREF_0		F27		
0	IO_L46N_0		M25		
0	IO_L46P_0		M26		
0	IO_L47N_0		L26		
0	IO_L47P_0		K26		
0	IO_L48N_0		H26		
0	IO_L48P_0		J26		
0	IO_L49N_0		F26		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
1	IO_L48N_1		J17		
1	IO_L48P_1		H17		
1	IO_L47N_1		K17		
1	IO_L47P_1		L17		
1	IO_L46N_1		M17		
1	IO_L46P_1		M18		
1	IO_L45N_1/VREF_1		F16		
1	IO_L45P_1		E16		
1	IO_L44N_1		G16		
1	IO_L44P_1		H16		
1	IO_L43N_1		K16		
1	IO_L43P_1		J16		
1	IO_L39N_1		M16		
1	IO_L39P_1		L16		
1	IO_L38N_1		C15		
1	IO_L38P_1		C14		
1	IO_L37N_1		F15		
1	IO_L37P_1		E15		
1	IO_L87N_1/VREF_1		J15	NC	
1	IO_L87P_1		H15	NC	
1	IO_L86N_1		K15	NC	
1	IO_L86P_1		L15	NC	
1	IO_L85N_1		E14	NC	
1	IO_L85P_1		D14	NC	
1	IO_L84N_1		G14	NC	
1	IO_L84P_1		F14	NC	
1	IO_L83_1/No_Pair		H14	NC	
1	IO_L78N_1		L14	NC	
1	IO_L78P_1		K14	NC	
1	IO_L36N_1/VREF_1		M14		
1	IO_L36P_1		M15		
1	IO_L35N_1		C13		
1	IO_L35P_1		D13		
1	IO_L34N_1		F13		
1	IO_L34P_1		E13		
1	IO_L30N_1		H13		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
2	IO_L44P_2		U10		
2	IO_L45N_2		U3		
2	IO_L45P_2		U4		
2	IO_L46N_2/VREF_2		U1		
2	IO_L46P_2		U2		
2	IO_L47N_2		T12		
2	IO_L47P_2		U12		
2	IO_L48N_2		V10		
2	IO_L48P_2		V11		
2	IO_L49N_2		V7		
2	IO_L49P_2		V8		
2	IO_L50N_2		U11		
2	IO_L50P_2		V12		
2	IO_L51N_2		V4		
2	IO_L51P_2		V5		
2	IO_L52N_2/VREF_2		V1		
2	IO_L52P_2		V2		
2	IO_L53N_2		W9		
2	IO_L53P_2		W10		
2	IO_L54N_2		W7		
2	IO_L54P_2		W8		
2	IO_L55N_2		W5		
2	IO_L55P_2		W6		
2	IO_L56N_2		W11		
2	IO_L56P_2		W12		
2	IO_L57N_2		W3		
2	IO_L57P_2		W4		
2	IO_L58N_2/VREF_2		W1		
2	IO_L58P_2		W2		
2	IO_L59N_2		Y9		
2	IO_L59P_2		Y10		
2	IO_L60N_2		Y6		
2	IO_L60P_2		Y7		
2	IO_L85N_2		Y3		
2	IO_L85P_2		Y4		
2	IO_L86N_2		Y11		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
2	IO_L22N_2/VREF_2	L4	
2	IO_L22P_2	L5	
2	IO_L23N_2	T8	
2	IO_L23P_2	T9	
2	IO_L24N_2	L3	
2	IO_L24P_2	K3	
2	IO_L25N_2	L1	
2	IO_L25P_2	L2	
2	IO_L26N_2	U12	
2	IO_L26P_2	V12	
2	IO_L27N_2	M7	
2	IO_L27P_2	L6	
2	IO_L28N_2/VREF_2	M5	
2	IO_L28P_2	M6	
2	IO_L29N_2	U10	
2	IO_L29P_2	U11	
2	IO_L30N_2	M3	
2	IO_L30P_2	M4	
2	IO_L31N_2	N6	
2	IO_L31P_2	N7	
2	IO_L32N_2	U7	
2	IO_L32P_2	U8	
2	IO_L33N_2	N3	
2	IO_L33P_2	N4	
2	IO_L34N_2/VREF_2	N2	
2	IO_L34P_2	M2	
2	IO_L35N_2	V10	
2	IO_L35P_2	V11	
2	IO_L36N_2	P6	
2	IO_L36P_2	P7	
2	IO_L37N_2	P1	
2	IO_L37P_2	P2	
2	IO_L38N_2	V8	
2	IO_L38P_2	V9	
2	IO_L39N_2	R6	
2	IO_L39P_2	P5	
2	IO_L40N_2/VREF_2	R4	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
6	IO_L52P_6	AF40	
6	IO_L52N_6	AF41	
6	IO_L53P_6	AC36	
6	IO_L53N_6	AC37	
6	IO_L54P_6	AE41	
6	IO_L54N_6	AE42	
6	IO_L55P_6	AE40	
6	IO_L55N_6	AD40	
6	IO_L56P_6	AC31	
6	IO_L56N_6	AC32	
6	IO_L57P_6	AE38	
6	IO_L57N_6/VREF_6	AE39	
6	IO_L58P_6	AD41	
6	IO_L58N_6	AD42	
6	IO_L59P_6	AB35	
6	IO_L59N_6	AB36	
6	IO_L60P_6	AD37	
6	IO_L60N_6	AD38	
6	IO_L85P_6	AC40	
6	IO_L85N_6	AC41	
6	IO_L86P_6	AB33	
6	IO_L86N_6	AB34	
6	IO_L87P_6	AC39	
6	IO_L87N_6/VREF_6	AB39	
6	IO_L88P_6	AB40	
6	IO_L88N_6	AB41	
6	IO_L89P_6	AB31	
6	IO_L89N_6	AB32	
6	IO_L90P_6	AB37	
6	IO_L90N_6	AB38	
7	IO_L90P_7	AA40	
7	IO_L90N_7	AA41	
7	IO_L89P_7	AA35	
7	IO_L89N_7	AA36	
7	IO_L88P_7	Y39	
7	IO_L88N_7/VREF_7	AA39	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
7	IO_L45N_7	T36	
7	IO_L44P_7	W32	
7	IO_L44N_7	W33	
7	IO_L43P_7	R41	
7	IO_L43N_7	R42	
7	IO_L42P_7	P40	
7	IO_L42N_7	R40	
7	IO_L41P_7	V36	
7	IO_L41N_7	V37	
7	IO_L40P_7	R38	
7	IO_L40N_7/VREF_7	R39	
7	IO_L39P_7	P38	
7	IO_L39N_7	R37	
7	IO_L38P_7	V34	
7	IO_L38N_7	V35	
7	IO_L37P_7	P41	
7	IO_L37N_7	P42	
7	IO_L36P_7	P36	
7	IO_L36N_7	P37	
7	IO_L35P_7	V32	
7	IO_L35N_7	V33	
7	IO_L34P_7	M41	
7	IO_L34N_7/VREF_7	N41	
7	IO_L33P_7	N39	
7	IO_L33N_7	N40	
7	IO_L32P_7	U35	
7	IO_L32N_7	U36	
7	IO_L31P_7	N36	
7	IO_L31N_7	N37	
7	IO_L30P_7	M39	
7	IO_L30N_7	M40	
7	IO_L29P_7	U32	
7	IO_L29N_7	U33	
7	IO_L28P_7	M37	
7	IO_L28N_7/VREF_7	M38	
7	IO_L27P_7	L37	
7	IO_L27N_7	M36	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
7	VCCO_7	AA29	
7	VCCO_7	Y29	
7	VCCO_7	W29	
7	VCCO_7	V29	
7	VCCO_7	U29	
7	VCCO_7	T29	
7	VCCO_7	R29	
7	VCCO_7	AA28	
7	VCCO_7	Y28	
7	VCCO_7	W28	
7	VCCO_7	V28	
7	VCCO_7	U28	
7	VCCO_7	T28	
6	VCCO_6	AU39	
6	VCCO_6	AN39	
6	VCCO_6	AJ39	
6	VCCO_6	AD39	
6	VCCO_6	AW37	
6	VCCO_6	AN35	
6	VCCO_6	AJ35	
6	VCCO_6	AD35	
6	VCCO_6	AR33	
6	VCCO_6	AL33	
6	VCCO_6	AH29	
6	VCCO_6	AG29	
6	VCCO_6	AF29	
6	VCCO_6	AE29	
6	VCCO_6	AD29	
6	VCCO_6	AC29	
6	VCCO_6	AB29	
6	VCCO_6	AG28	
6	VCCO_6	AF28	
6	VCCO_6	AE28	
6	VCCO_6	AD28	
6	VCCO_6	AC28	
6	VCCO_6	AB28	
5	VCCO_5	AW33	